

(2.00 mm) .0787"

BLE THROUGH-HOLE HEADER

SPECIFICATIONS

For complete specifications see www.samtec.com?TMMH

Insulator Material: Black Liquid Crystal Polymer
Terminal Material:

Phosphor Bronze
Plating:
Sn or Au over
50 μ" (1.27 μm) Ni
Current Rating (TMMH/ESQT): 4.5 A per pin (2 pins powered)
Current Rating (TMMH/SQT): 5.1 A per pin

5.1 A per pin (2 pins powered) Operating Temp Range: -55 °C to +105 °C with Tin; -55 °C to +125 °C with Gold Voltage Rating: 281 VAC mated with SQW; 250 VAC mated with SQT

RoHS Compliant:

Lead-Free Solderable: Yes

Board Mates:

CLT, SQT, SQW, ESQT, TLE, SMM, MMS

Cable Mates:



Choice of 2, 3, 4, 5 and 6 rows on (2.00 mm) .0787" pitch (2.00 mm).0787" Through-hole (2.00 mm) ALSO AVAILABLE .0787" (MOQ Required)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



Note:

Some lengths, styles and options are non-standard, non-returnable.

Other Solutions





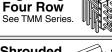
Surface Mount

See previous page.



Low Profile See TMM Series.







Paste In Hole (PIH) processing. Contact Samtec ASP Group for part customization.

TMMH

APPLICATION

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Retention Clip Option (-RC)



03 thru 50

NO. PINS PER ROW

LEAD STYLE

· Other platings

Contact Samtec.

PLATING

OPTION

= Gold flash

on post,

Matte Tin on tail

= 10 µ" (0.25 µm)

Gold on post,

Matte Tin on tail

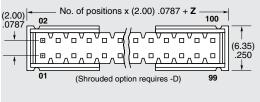
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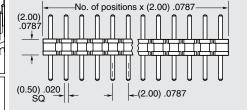
= Matte Tin

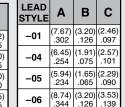
Specify LEAD STYLE

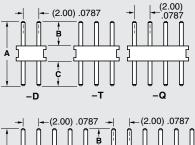
from chart

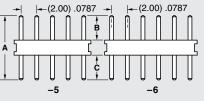
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00 ↓	-ES	(2.92)	-01	(7.67) .302	(3.20) .126	
No. of rows	-EC	(4.70) .185	-04	(6.45) .254	(1.91) .075	
(2.00)	-EP & -EPC	(6.10) .240	-05	(5.94) .234	(1.65) .065	
95	-EL & -EBC	(4.45) .175	-06	(8.74) .344	(3.20) .126	
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Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM

